

ATLANT 3D[®]



www.atlant3d.com

● COMPANY BROCHURE

PROGRAMMABLE MATTER

Physical AI Infrastructure for the Next Materials
Revolution

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ABOUT US

ATLANT 3D is a deep-tech company pioneering atomic-scale manufacturing with its proprietary Direct Atomic Layer Processing (DALP®) platform technology.

Our platform enables rapid materials, device prototyping, and industrial integration with seamless scale-up from lab to production, accelerating innovation across semiconductors, advanced packaging, energy, sensors and space.

VISION

To enable humanity to discover, design and physically realize new materials that advance society.

MISSION

Enabling AI-driven materials discovery infrastructure by turning digital material intelligence into programmable matter for industry impact.

OUR STORY

Founded in 2018 with ATLANT 3D HQ in Copenhagen, Denmark, ATLANT 3D empowers future innovators with new materials, Atom by Atom®. We accelerate the transition from lab-to-fab and enable fab-in-lab materials discovery and manufacturing to bring breakthrough materials and novel device architectures to market rapidly, responsibly, and at scale.

OUR TEAM

Powered by 40+ experts spanning:

- Materials Discovery & Process Development
- Atomic Layer Processing (ALD, ALE, MLD)
- Advanced Applications & Devices
- Systems & Software Engineering
- Strategic Growth & Business Development

PARTNERS & CUSTOMERS

SONY



NASA



MERCK



SIEMENS



OUR JOURNEY

2026

- ✓ Expands European Research Partnership with Deployment of NANOFABRICATOR® LITE at the Slovak Academy of Sciences.
- ✓ MoUs signed with NUS I-FIM and A*STAR NAMIC and IMRE partnering on A-HUB Singapore, an AI-driven materials discovery foundry.



2025

- ✓ XTC Pitch Winner for Semiconductors & Ecosystems.
- ✓ NANOFABRICATOR® ZERO-G with ESA completed.



2024

- ✓ First sale of NANOFABRICATOR® LITE.
- ✓ Development of the NANOFABRICATOR® PRO industrial platform.
- ✓ €13M Series A+ secured.



2023

- ✓ Commercial release of NANOFABRICATOR® LITE.
- ✓ Launched A-HUB Copenhagen: first end-to-end advanced manufacturing centre of excellence.
- ✓ 6 New Pilots.



2022

- ✓ €13M Series A funding secured, led by West Hill Capital.
- ✓ Developing NANOFABRICATOR® ZERO-G system for ESA International Space Station.



2021

- ✓ First sale of NANOFABRICATOR® prototype to NASA.



2020

- ✓ Pre-seed funding by Sony won.
- ✓ €10M government-funded projects (10 partners).
- ✓ €3.6M EU project.
- ✓ Pilot with Sony.



2019

- ✓ Filed 1st patent application PoC.
- ✓ Pilot with Merck.



MESSAGE FROM THE CEO

At ATLANT 3D, we believe that every major leap in human civilization has been driven by advances in materials. From the Stone Age and the Bronze Age to the Silicon Age and beyond, breakthroughs in materials have continually shaped human progress.

As we enter the age of AI, our mission is to provide the end-to-end physical infrastructure that accelerates the discovery, development, and manufacturing of advanced materials and devices at the atomic scale. By empowering innovators with faster and more efficient pathways from research to production, we help unlock the next generation of technologies across critical industries including AI-driven materials discovery, semiconductors, advanced packaging, MEMS & sensors, neuromorphic computing, quantum, energy, aerospace, and more.

We believe that materials innovation at the atomic scale opens new possibilities for solving some of the world's most complex challenges. Through our technology, we enable a faster, more sustainable, and more scalable approach to bringing advanced materials from discovery to real-world application.

ATLANT 3D is pioneering a new era of rapid materials discovery and atomic-scale manufacturing with the world's first digitally-defined atomic-layer advanced manufacturing platform. By bridging the gap between innovation and industrialization, we accelerate the development of transformative technologies and scalable end-use applications that will define the future.

Dr. Maksym Plakhotnyuk
CEO & Founder

OUR PROPRIETARY TECHNOLOGY

Bridging digital intelligence and industrial fabrication to enable AI-driven materials discovery, process development and integration into scalable production.

DALP® Technology

DALP® enables direct, localized atomic-scale material processing by positioning a micronozzle at a controlled working distance above a moving substrate.

ATLANT 3D's proprietary Direct Atomic Layer Processing (DALP®) platform technology supports precise deposition and etching of multiple materials, reducing reliance on conventional batch-based fabrication workflows and enabling software-defined manufacturing at the atomic scale.

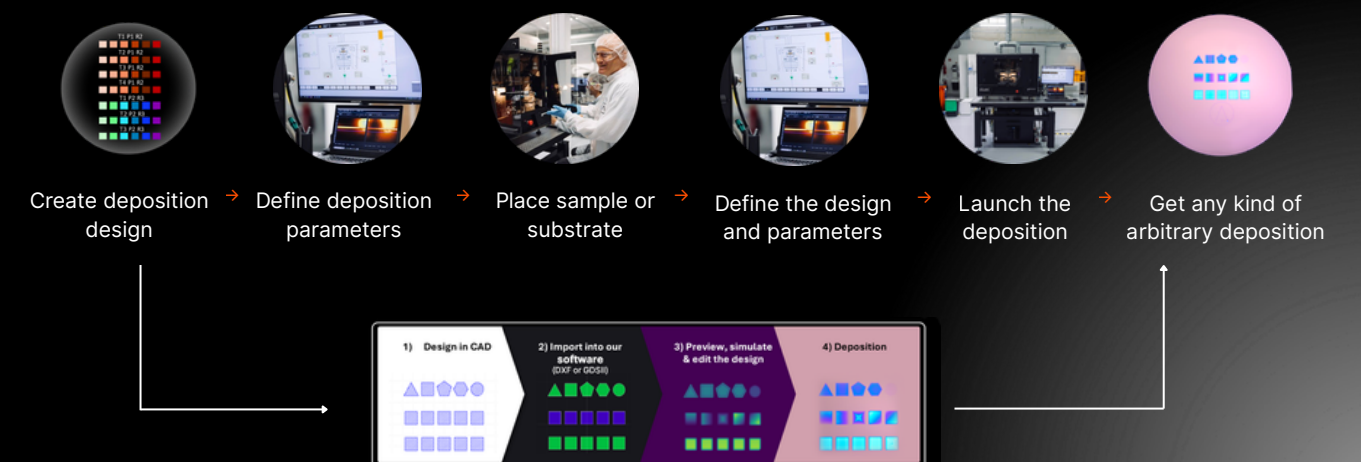
“As a scientist, I believe the future of innovation depends on our ability to discover, develop, and manufacture new materials faster and more precisely than ever before. At ATLANT 3D, we are building the platform that allows researchers and engineers to develop advanced materials and devices with atomic-scale precision, accelerating the transition from R&D to industrial impact.”

Dr. Mira Baraket
Chief Technology Officer



End-to-End Process Workflow

A seamless process from digital design to physical fabrication, enabling rapid iteration and scalable production.



DALP® TECHNOLOGY BENEFITS

Why it Matters

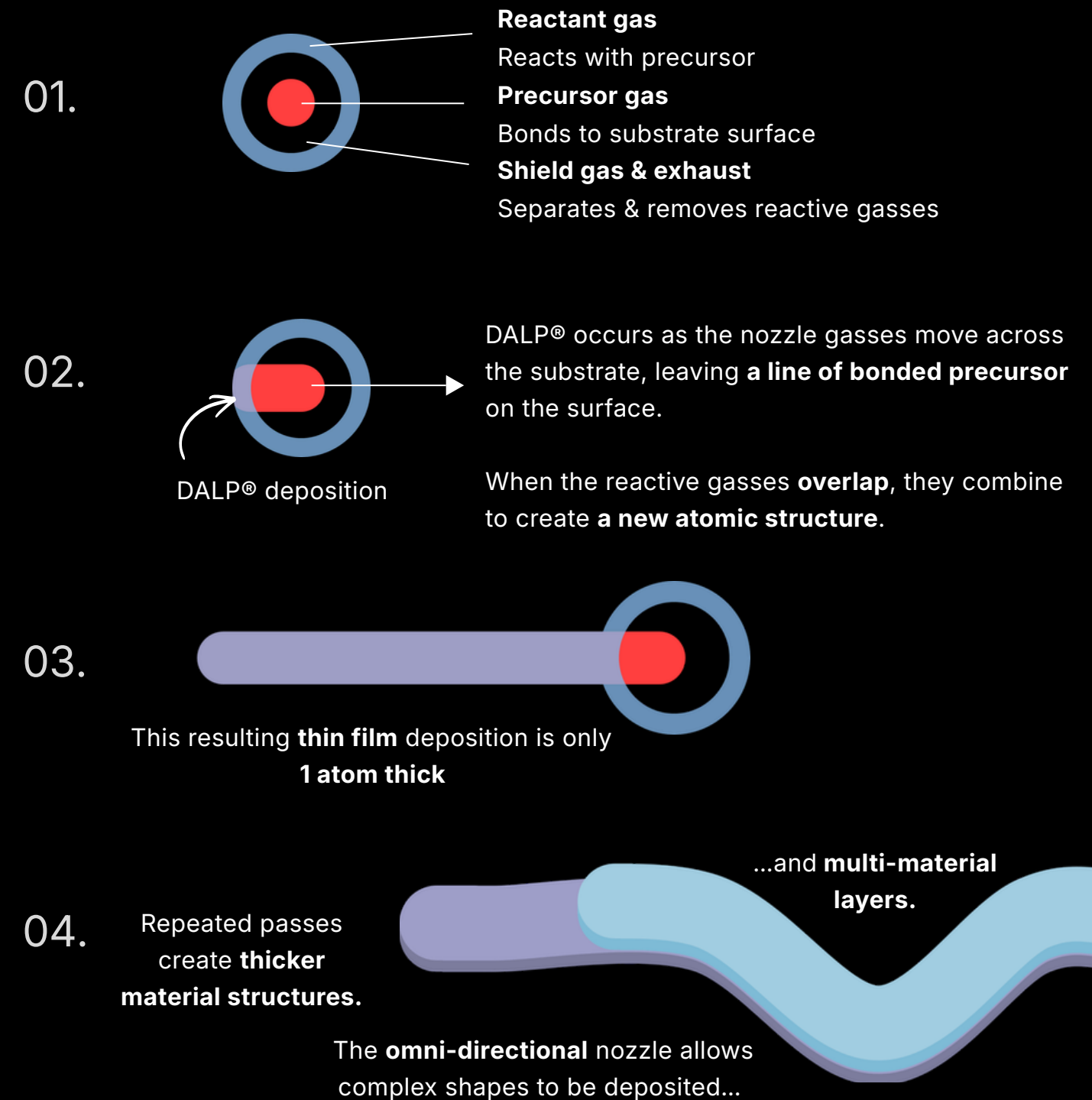
- Accelerates materials innovation **from years to days**
- Accelerates device prototyping and industrial integration
- Enables direct transition **from lab to fab**
- Reduces reliance on complex global supply chains
- Supports more **sustainable** and **localized manufacturing**

Key Advantages

- ✓ Direct-write patterning at micron scale
- ✓ Localized ALD, ALE, and MLD processes
- ✓ No photoresist, masks or etching
- ✓ Multi-material deposition in a single workflow
- ✓ Reduced process steps & tool transfers

HOW IT WORKS

ATLANT 3D's patented micronozzle channels reactive & shield gasses into the pattern shown:



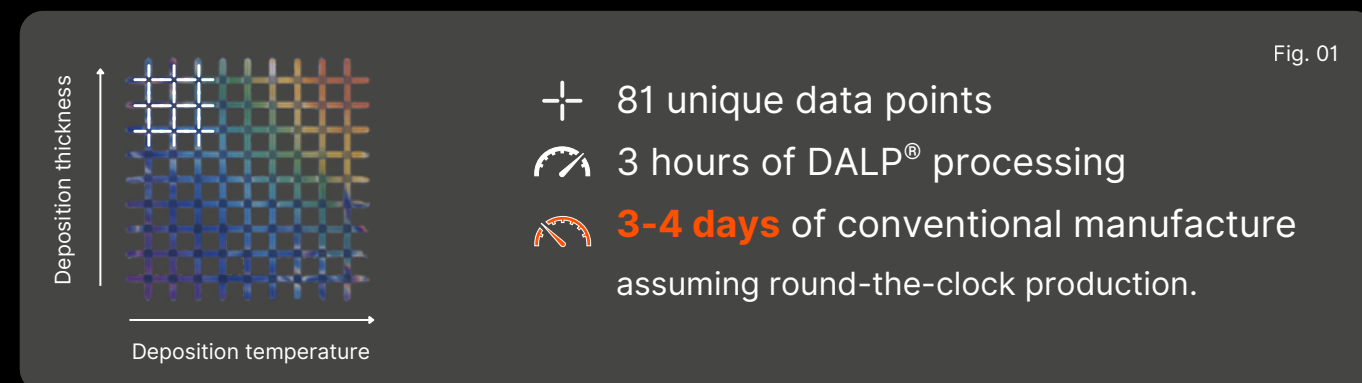
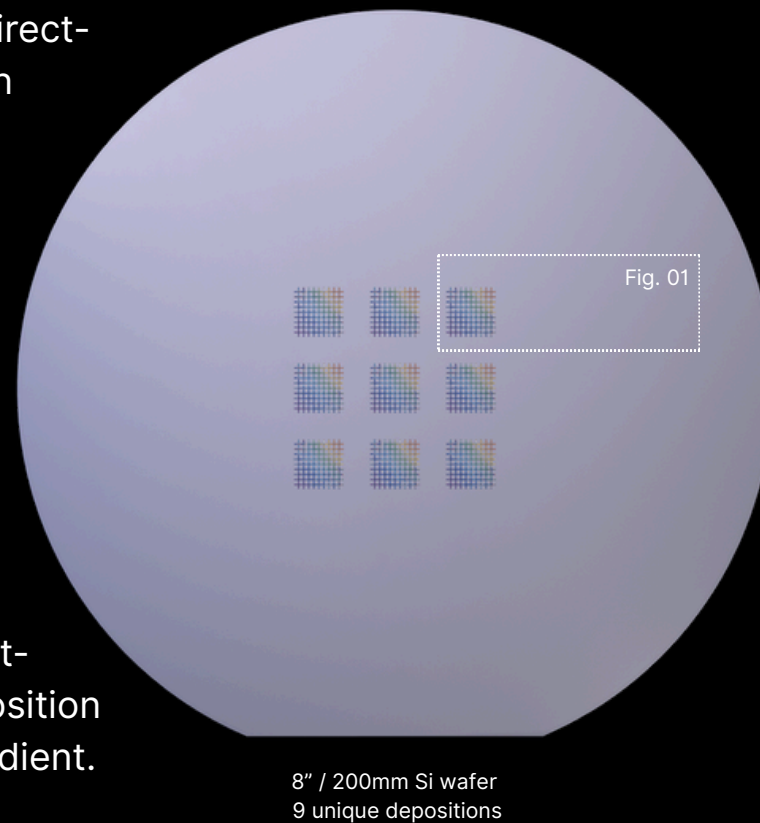
ACCELERATING INNOVATION WITH DALP® ...

DALP® technology is applicable to a multitude of applications at every stage of development, from R&D to prototyping and fabrication.

As DALP® is a lithography-less, direct-write process, the speed at which experimental designs can be deposited, characterized, iterated, and re-deposited is orders of magnitude faster than conventional processing techniques.

In this example, a material is deposited in a grid comprising single lines. In one axis, the lines increase in thickness along a controlled gradient. In the other, deposition temperature is increased in a gradient.

Every intersection provides a unique ratio of material properties. In a matter of hours, thousands of unique data points can be produced. Using conventional techniques would take months.



... FROM MONTHS TO HOURS

In this example deposition, 9 unique depositions, producing a total of 729 unique data points, were printed on a single silicon wafer.

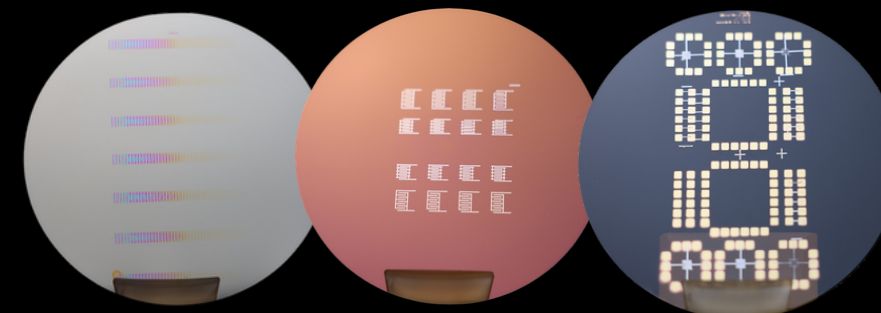
The entire deposition takes less than a day and is fully automated, allowing it to run overnight and without an operator.

The deposition is ready to be characterized, tested, or implemented immediately, with no post-processing steps required.

- + 729 unique data points
- + 18 hours of DALP® processing
- + 1 month of conventional manufacture to produce an equivalent quantity of data.

Using the NANOFABRICATOR®'s design software, DALP® Designer, complex patterns and structures can be created, driving a breadth of experimental and fabrication possibilities.

NANOFABRICATOR® PRO's advanced integration capabilities now enable the development process to accelerate even further, with automated wafer handling, in-situ metrology, QA, and closed-loop feedback – the ideal hardware setup for integrated AI.

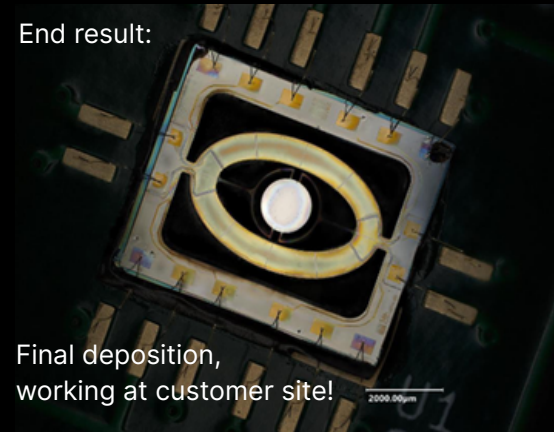


From left to right:
Material Development, Device
Prototyping, Device Fabrication

APPLICATIONS OF DALP®

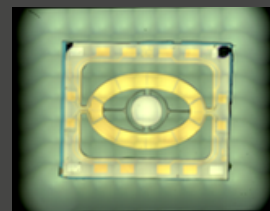
Examples of how DALP® platform technology is being used in emerging markets:

End result:



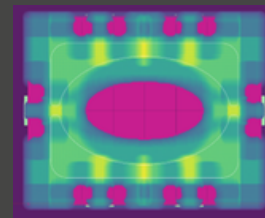
Final deposition, working at customer site!

ADVANCED PACKAGING: ENCAPSULATION LAYERS



1. Chips

2. Deposition preview

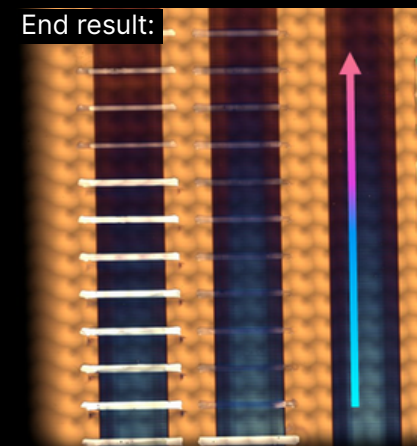


Collaborator: SAL SILICON AUSTRIA LABS



3. Deposition result after taking the chip off the support wafer

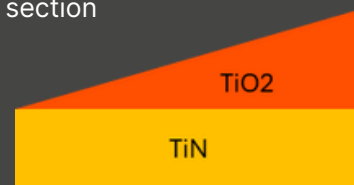
End result:



150-stack configuration completed in 15 hours (NANOFABRICATOR® LITE), down from 10 weeks.

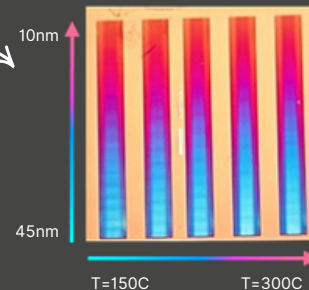
RAPID PROTOTYPING: ELECTROCHEMICAL SENSORS

Schematic cross-section

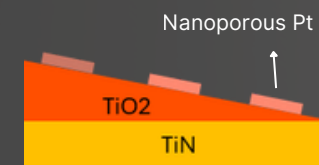


1. Optimization of the second layer with a gradient

2. Deposition (with continuous TiO2 gradient) & measurement

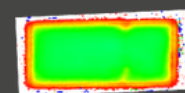


3. Optimization of the third layer with various deposition temperatures

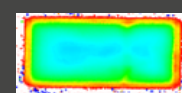


See 'End result'

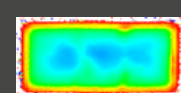
DIRECT AND LOCAL EDGE PASSIVATION: SOLAR CELL



Before passivation



After passivation



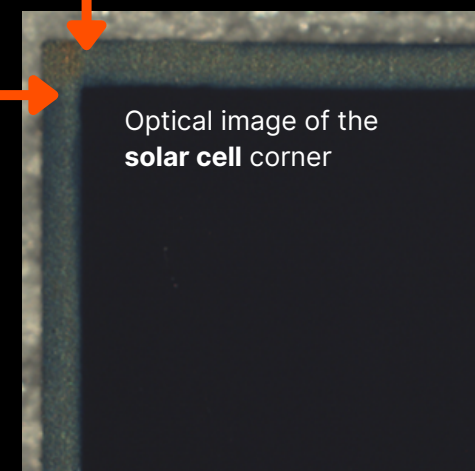
After annealing T1

Higher carrier lifetime →



Result:
Carrier lifetime improvement after edge passivation

End result:



Nandan Singh Ruhela
Process Engineer, Technology R&D
Taken in A-HUB Copenhagen, Denmark

OUR MARKETS & APPLICATIONS

ATLANT 3D operates across multiple frontier markets, enabling advanced materials innovation and next-generation device fabrication across diverse applications.

01

COMMUNICATION



- RF & High-Frequency Interconnects

02

SEMICONDUCTOR



- Advanced Packaging HBM

03

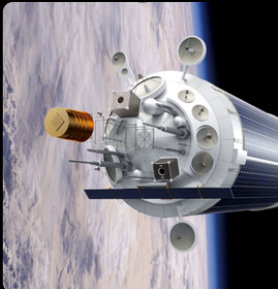
AI & QUANTUM TECHNOLOGIES



- Edge Computing & Quantum Devices

04

AEROSPACE & DEFENSE



- Secure Sensors & Space-Grade Devices

05

ADVANCED MATERIALS



- AI-Driven Materials Discovery

06

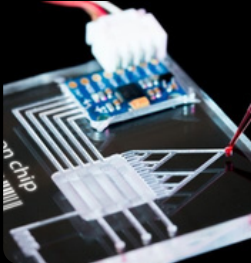
MOBILE & CONSUMER



- Smartphone Assembly & Bonding

07

HEALTHCARE & LIFE SCIENCES



- Lab-on-Chip & Biosensors

08

AUTOMOTIVE



- Power Electronics

09

ENERGY & ENVIRONMENT



- Catalysts & Battery Materials

10

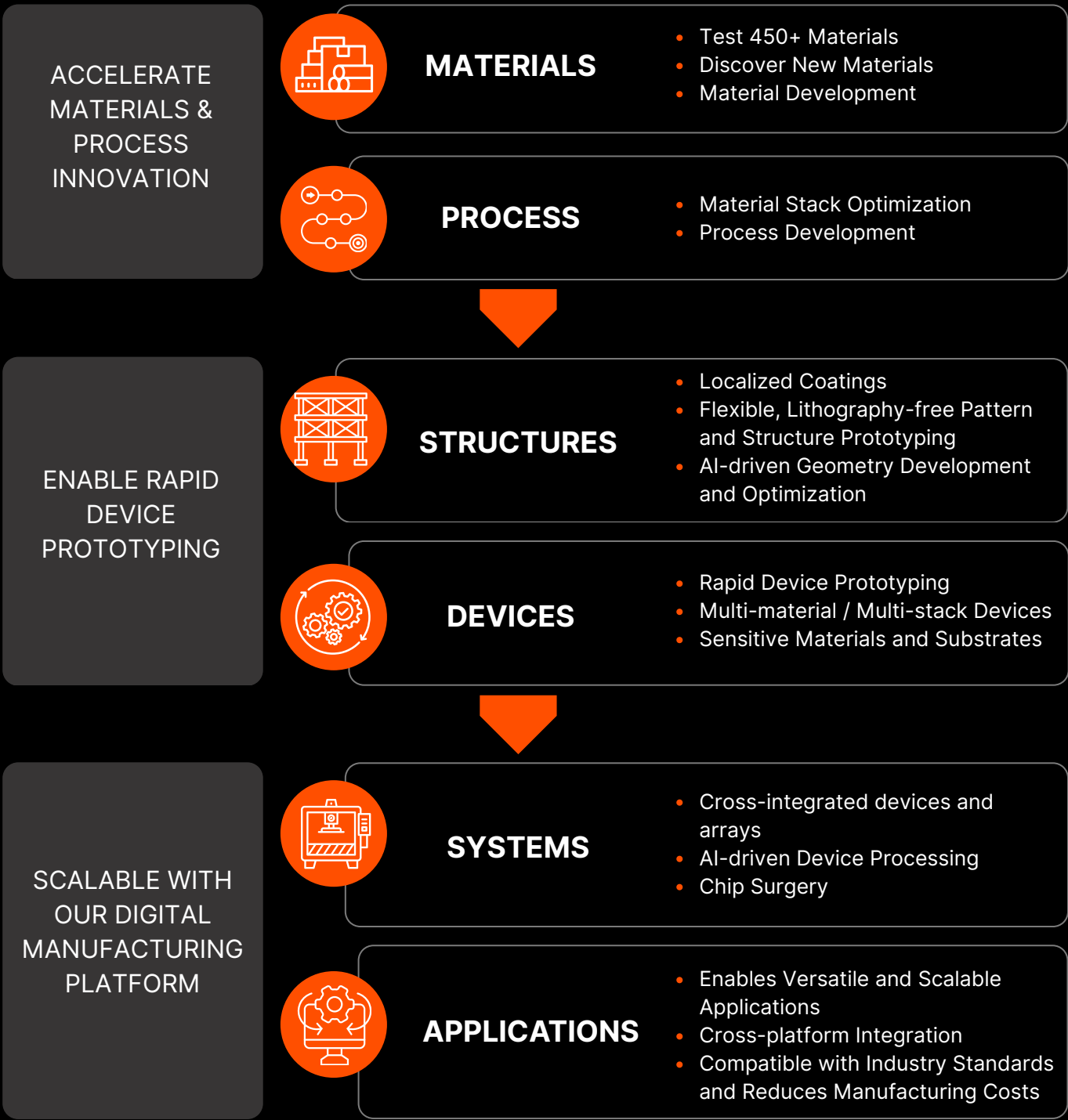
LUXURY PRODUCTS



- Precision Surface Finishing

OUR PLATFORM

Lab-to-fab and fab-in-lab: one platform for materials discovery, process development, and device solutions.



NANOFABRICATOR® ZERO-G

Our DALP®-enabled platform for in-space microfabrication and advanced prototyping in microgravity environments enables high-precision material processing, localized microdevice repair, and reliable operation in space.

Trusted By:   



Zero gravity, maximum precision

OVERVIEW

The NANOFABRICATOR® ZERO-G utilizes ATLANT 3D’s DALP® technology in a space-qualified configuration, enabling localized atomic layer processing in microgravity. Its system architecture supports precise, controlled material deposition for in-space fabrication, prototyping, and repair.

FEATURES

Designed for microgravity environments, ZERO-G enables precise, localized fabrication, autonomous operation, and resource-efficient processing, supporting next-generation manufacturing beyond Earth.

- Key features:
- Microgravity-compatible, space-qualified system
 - Localized, high-precision atomic layer deposition
 - In-space fabrication, prototyping, and repair
 - ISS-compatible design (EDR2 integration)
 - Autonomous operation with remote control capability

TECHNICAL SPECIFICATIONS

Substrate	Size	Up to 2"
	Holding	Mechanical, vacuum
	Material	Si Wafer
	Sample Shape	Flat
	Holder Temperature	275°C - 300°C
Process chamber	Environment	Ambient
	Processing Speed	50nm/ sec
	Resolution	400 µm
Control	Control Deposition	Automated
Gas system	Temperature	Max 100°C
	No. Carrier gas	N2
	No. Precursor bubblers	1 as standard
	No. Reactant bubbler(s)	1 as standard
	Weight	65Kg
Power	Tool power requirements	28 VDC, 10 A



NANOFABRICATOR® LITE

Our benchtop DALP®-enabled platform for material, process, and device R&D.

Trusted By:



LITE on size, heavy on capabilities

OVERVIEW

The NANOFABRICATOR® LITE utilizes ATLANT 3D's DALP® technology with an interchangeable and modular micronozzle system, enabling precise, software-defined localized material processing for diverse materials, processes and applications R&D.

FEATURES

The NANOFABRICATOR® LITE can be configured to support up to six bubblers: three precursors and three reactants. The standard platform operates in an ambient open atmosphere and can be upgraded with an inert chamber for controlled environments.

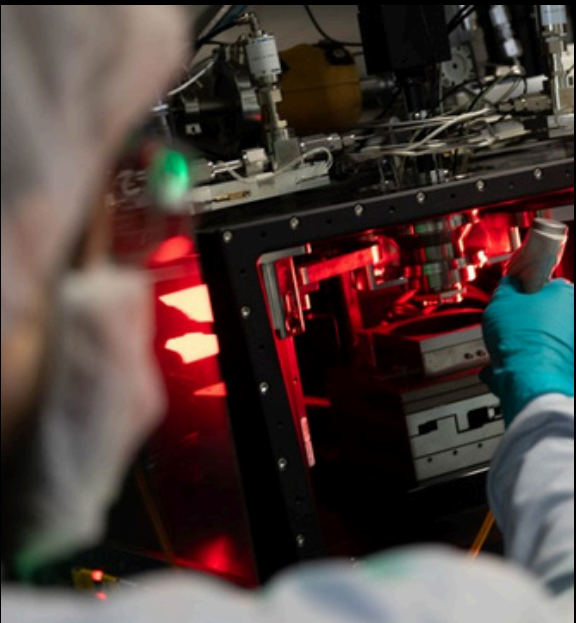
LITE performs atomic-layer processes, including deposition and etching, in an ambient, uncontrolled environment and is fully inert-capable with the inert-chamber upgrade.

Key features:

- Benchtop tool, with a 0.8 x 1.4 meter footprint
- 200mm/s max. processing speed
- Up to 4" (100 mm) sample size
- Multi-material deposition
- Standard nozzle is 400um line width (micronozzles are interchangeable)

TECHNICAL SPECIFICATIONS

Substrate	Size	1" to 4" wafer. Max. 10 mm thickness
	Holding	Vacuum (triple zone)
	Handling	Manual operator handling
	Heater	Max. 300°C (+/- 1%)
Process chamber	Environment	Ambient, uncontrolled
	With inert module (optional upgrade)	Inert (Ar), controlled
Motion control	Deposition speed	Max. 200 mm/second
	Deposition resolution	350-400 µm DALP® resolution
	Deposition volume	100 x 100 x 25 mm (x, y, z) Up to 1.5 mm from substrate edge.
Substrate positioning	Nozzle-substrate gap measurement	Interferometry
	Nozzle-substrate gap verification	Side camera, real-time view
	Sample scanning & positioning	Top camera, real-time view
Gas system	DALP® temperature	Max 150°C
	Bubbler temperature	Max 130°C
	No. Precursor bubblers	2 as standard, Max. 3
	No. Reactant bubbler(s)	1 as standard, Max. 3
	No. Reactant gas line(s) / interface	1 as standard, Max. 2
	Upgrade: Ozone generator	0 as standard, Max. 1
Power	Tool power requirements	208-240 VAC, 50-60 Hz, 30 A



NANOFABRICATOR® PRO

Our DALP®-enabled platform for industrial R&D and pilot production of advanced materials, process development, and advanced manufacturing.

Trusted By: **SONY**  



Built for scale, driven by performance

OVERVIEW

The NANOFABRICATOR® PRO uses ATLANT 3D's DALP® technology with a modular system configuration designed for scalable atomic layer processing. It enables precise, software-defined localized multi-material processing, including deposition and etching, with enhanced control, enabling materials and process development for a seamless transition to production-ready manufacturing.

FEATURES

The NANOFABRICATOR® PRO is the first atomic-layer material discovery and process integration platform built for industrial R&D, material and device development, and industrial fabrication. PRO is SEMI standards compliant and can process multi-material stacks under an ultra-clean controlled environment on wafers up to 8" (compatible with upgrade to 12").

PRO accelerates testing, enables iterative prototyping in hours, and transforms breakthrough ideas into scalable, production-ready processes for next-generation devices.

Key features:

- Multi-material deposition
- 50–400 μm line width for precise patterning (micronozzles are interchangeable)
- Up to 8" (200 mm) substrate, compatible with upgrade to 12"
- 500 mm/s maximum deposition speed
- Ultra-clean controlled process chamber



INTEGRATION & AUTOMATION

The NANOFABRICATOR® PRO is the first atomic-layer materials discovery and process-integration platform built for industrial R&D, material and process development, device innovation and Industrial fabrication.

It deposits multiple materials sequentially under ultra-clean controlled conditions on wafers up to 8" or custom substrates with unrivaled versatility.

PRO accelerates testing, enables iterative prototyping in hours, and transforms breakthrough ideas into scalable, production-ready processes for next-generation devices.

TECHNICAL SPECIFICATIONS

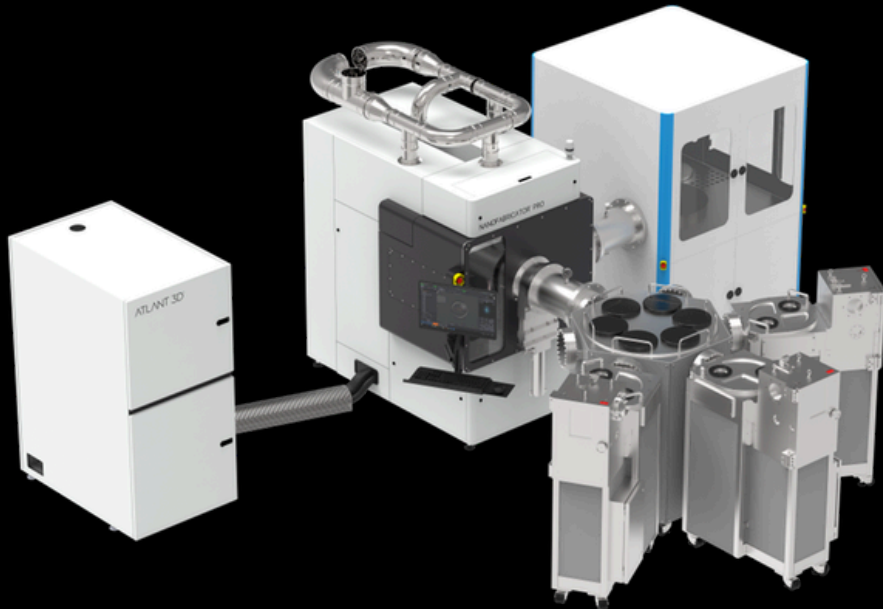
Power	Voltage	208-230 VAC
	Frequency	50-60 Hz
	Phase configuration	1 Phase (1W+N+G) 2 Phase (2W+G)
Substrate	Substrate Size	Up to 8" (200 mm) wafer, including common sizes such as: 4" (100 mm) 6" (150 mm) 8" (200 mm)
	Max Thickness	2 mm
	Z/Vertical Direction Shape	Flat
	Holding Method	Vacuum (3 separate zones)
	Loading Method	Manual, by operator
	Heater Temperature	Max 400°C
	Heater Uniformity	± 1%
Processing Chamber	Environment	Controlled inert environment
	Processing Speed	Up to 500 mm/s
	Deposition Area	Up to 1.5 mm from wafer edge
	DALP® Resolution	50-400 µm
Gas System	Precursor Temperature	RT to 150°C
	No. of Precursor Bubbler	2 (Upgradable to 3)
	No. of Reactant Bubbler	1 (H ₂ O default)
	No. of Gas Reactant Interface	1 (Upgradable to 2)
Motorized Linear stage	Gas compatibility	O ₂ , O ₃ , 1-10% NH ₃
	Horizontal X Travel	+/- 100 mm (200 mm total)
	Horizontal Y Travel	+/- 100 mm (200 mm total)
	Vertical Z Travel	+/- 12 mm (24 mm total)
	Max. velocity	Design: 500 mm/s
Gap Measurement	Gap Measurement	Interferometry
	Gap Verification (Go/No-Go)	Side Camera
Head	Head Adjustment	Linear Actuators (Vertical Axis)
Sample	Sample Scanning	Top Camera
	Weight	1000 kg (2200 LB)
System	Dimensions	Depth: 1820 mm
		Width: 1200 mm
		Height: 1932 mm



NANOFABRICATOR® PRO:
CLUSTER-INTEGRATED

Our DALP®-enabled platform for industrial fabrication and high-throughput production. Designed for fully automated sample handling, integrated metrology, and scalable manufacturing.

In the cluster configuration below, PRO interfaces with adjacent tools on two sides, enabling the continuous pre- and post-processing of wafers. This specific configuration is purely illustrative, and real-world setups and integrated equipment are based on application needs.



THE CORE OF DALP®: NOZZLE ARCHITECTURE

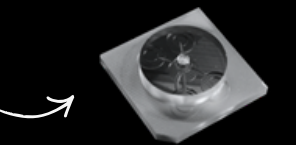
Engineered for precision and adaptability, enabling localized material processing at the heart of every DALP® system.

A dedicated team continuously develops advanced nozzle architectures to meet evolving material and application requirements.

NOZZLE TYPES

+ DALP® Micronozzle

Enables localized material deposition with high precision.
Line width: 350–400 µm (finer resolutions in development).



+ Blank Nozzle

Used to seal and cap the gas system when not in operation.

+ Purge Nozzle

Designed for efficient purging of gas lines, ensuring system cleanliness and process stability.

SOFTWARE

Our NANOFABRICATOR® platforms are operated with the same software, our custom interface for building experimental designs and launching jobs.

There are two software solutions, providing a fully developed suite of tools at different stages of the process: DALP® Designer and DALP® Pilot.

DALP® Designer Software

DALP® Designer is the design and simulation software for preparing device and experimental layouts for DALP® processing. It allows users to:

- Import or draw device and experimental designs
- Assign material recipes
- Set deposition properties
- Generate deposition previews
- Export projects directly to DALP® Pilot

DALP® Designer enables a smooth transition from design to automated deposition.

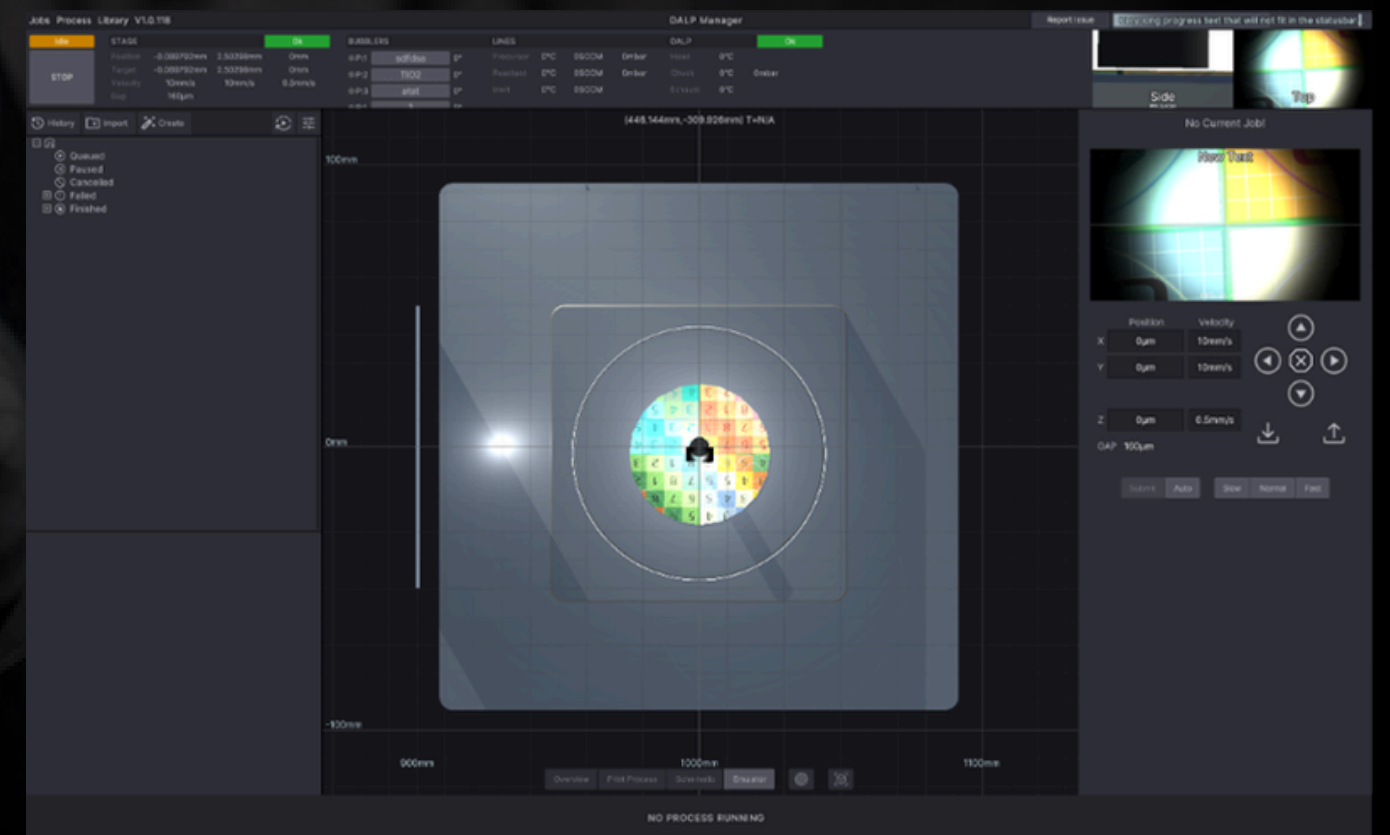


DALP® Pilot Software

DALP® Pilot is the machine control software and allows:

- Automated deposition process with guided instructions
- Scheduling of processing jobs
- Monitoring of vital machine parameters
- Capturing of process telemetry

The DALP® Pilot software can import complete projects from design, including deposition trajectories, metadata for recipe control, and alignment markers.



DALP® Pilot software showing the "virtual" chuck in the middle, the job queue on the left, and the camera view and stage controls on the right. The top of the screen shows selected telemetry values.

INNOVATION-AS-A-SERVICE

At ATLANT 3D, we offer a structured, low-risk pathway from complex challenges to validated, production-ready processes, engaging seamlessly at any stage of your innovation journey.



Proof of Concept

Rapidly validate technical feasibility with minimal risk.



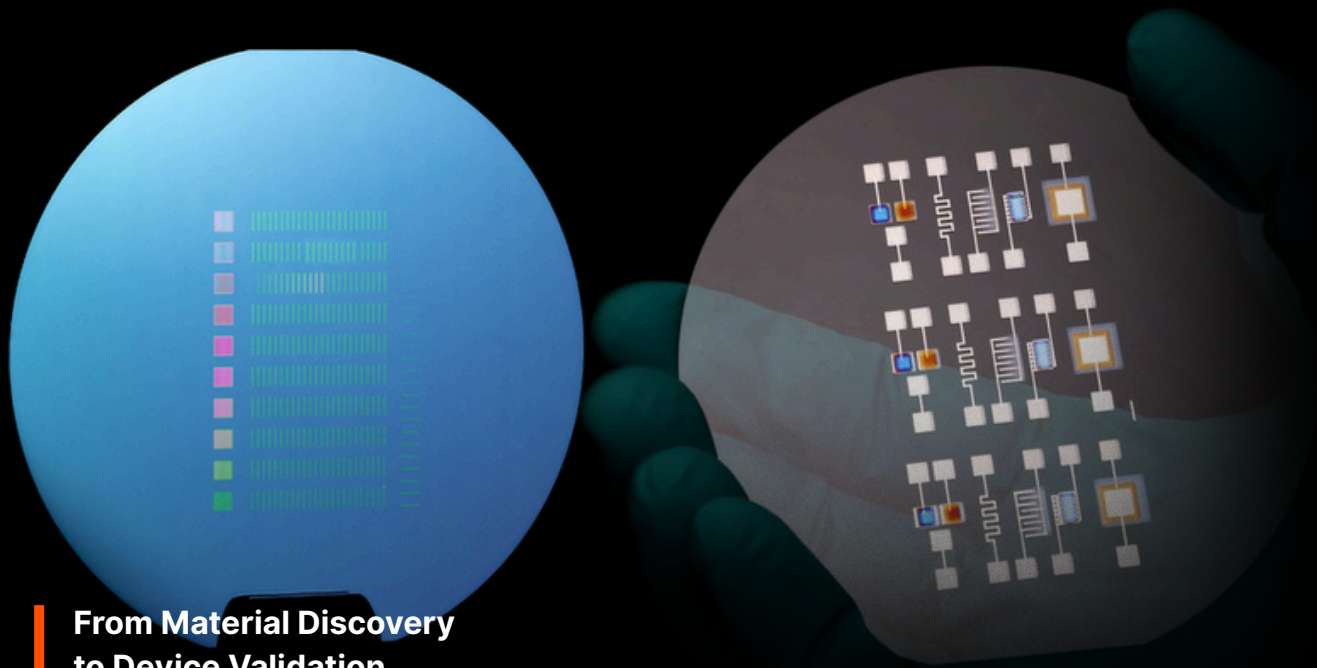
Pilot

Refine and optimise processes for production-relevant conditions.



Joint Development

Collaborate on application-specific innovation and IP development.



From Material Discovery
to Device Validation



Proof of Concept

0.5 – 2 months

We address your material or process challenge through rapid feasibility testing on our DALP® platform, delivering early validation with minimal upfront commitment.

What you get:

- Feasibility validation on your specific use case
- Initial performance data and reference results
- Clear go/no-go recommendation for next steps



Pilot Project

2 – 6 months

A focused engagement to validate and optimise processes on your substrates, ensuring alignment with your target manufacturing environment.

What you get:

- Process validation on customer substrates
- Optimized and application-specific deposition recipes
- Defined pathway to Joint Development or equipment deployment



Joint Development

6 – 12 months

A collaborative program to develop application-specific materials and processes, enabling industrial-scale validation and a clear path to deployment.

What you get:

- Co-funded development programs with shared objectives
- Jointly developed materials, processes, and application IP
- Production-ready validated processes

CUSTOMER SUCCESS & SUPPORT

We support our customers at every stage, from initial setup to process development and long-term operation, ensuring successful adoption and scalable results.

INSTALLATION & ONBOARDING

Seamless system installation and onboarding, ensuring smooth integration into your existing workflows with minimal disruption and rapid time-to-operation.

TRAINING & APPLICATION SUPPORT

Comprehensive training and application guidance to empower your team with the knowledge and skills needed to fully utilize the system's capabilities.

UPGRADES & OPTIMIZATION

Continuous system upgrades and performance optimisation to support evolving requirements and enable long-term scalability.

PROCESS DEVELOPMENT SUPPORT

Dedicated expert support to accelerate material discovery and process optimisation, helping you efficiently achieve reliable, high-performance results.

ONGOING TECHNICAL SUPPORT

Responsive and reliable technical assistance to ensure continuous operation, minimize downtime, and maintain optimal system performance over time.



A-HUB

A-HUB is ATLANT 3D's advanced innovation centre of excellence, a material and device innovation foundry with pilot production capability powered by DALP® technology, where partners and customers discover, develop, and scale new materials, processes and devices without the cost and complexity of building the infrastructure themselves.

WHAT A-HUB DELIVERS

- **End-to-End Process**
From early materials discovery, process development to device prototyping and industrial pilot production, all in one place.
- **Faster Time to Market**
Iteration in days, not years. Validation in weeks, not months.
- **Integrated Ecosystem**
DALP® technology, application expertise, and a network of strategic, industrial, research, and public partners working together.
- **Flexible Engagement**
Use our flagship hub as a service, or co-build one in your country.

SCALING THROUGH A-HUB

A-HUB enables localized and scalable deployment of ATLANT 3D's DALP® technology, bringing materials innovation closer to partners and accelerating the transition from lab-to-fab.

LOCALIZED INNOVATION HUBS

A-HUBs act as distributed micro-foundries powered by DALP®, enabling materials and process development, device innovation, and co-development close to end users.

SCALABLE DEPLOYMENT MODEL

Providing flexible access to ATLANT 3D technology without large upfront investment, supporting rapid prototyping and seamless scale-up from R&D to pilot production.

Key Ecosystem Partners:

SONY

ST

ThalesAlenia
Space

esa

SIEMENS

NAMIC
NATIONAL ADDITIVE MANUFACTURING
INNOVATION CLUSTER

NUS
National University
of Singapore

a
Agency for
Science, Technology
and Research
SINGAPORE

**DANISH
TECHNOLOGICAL
INSTITUTE**

FAU
Friedrich-Alexander-Universität
Erlangen-Nürnberg

THE A-HUB ECOSYSTEM

A-HUB integrates technology, expertise, and partnerships to support customers across the entire innovation lifecycle and enables a seamless transition from discovery to industrial deployment.



Technology

Enabling precise, atomic-scale material engineering through advanced fabrication platforms.

- DALP® platform for localized, multi-material deposition
- Integrated hardware and process control
- Scalable from R&D to industrial applications



Expertise

Combining deep application knowledge with R&D support to accelerate innovation.

- Application and process development support
- Rapid prototyping and validation
- Industry-specific know-how



Partnerships

Collaborating across industry, research and public stakeholders to bring innovations to real-world impact.

- Strategic industry collaborations
- Research and academic partnerships
- Pathways to industrial deployment in strategic verticals

PARTNER WITH US

At ATLANT 3D, we collaborate with partners across academia, industry, and government to accelerate materials innovation and enable scalable, real-world impact across industries.

TECHNOLOGY & INNOVATION PARTNERSHIPS

Work with us to explore new materials, co-develop processes, and accelerate innovation using our DALP® platform technology.

RESEARCH & ACADEMIC COLLABORATIONS

Engage in joint research, knowledge exchange, and talent development to bridge science and industrial application.

INDUSTRIAL DEPLOYMENT

Integrate ATLANT 3D systems into your development and production workflows to accelerate time to market and scale capabilities.

A-HUB PARTNERSHIPS

Partner with ATLANT 3D to establish or participate in A-HUBs, enabling localized innovation and access to advanced materials infrastructure.



“Across industries ranging from AI-driven materials discovery, semiconductors and advanced packaging to MEMS/sensors, energy, aerospace, and beyond, our customers and partners are pushing the boundaries of what is possible. Whether you are exploring new materials, developing next-generation devices, or building the technologies of tomorrow, ATLANT 3D is the partner that helps accelerate innovation at every stage of the journey.

Dr. Bonnie Tsim
VP of Commercial Strategy and Partnerships



LET'S BUILD THE FUTURE OF MATERIALS INNOVATION TOGETHER.

START THE CONVERSATION

www.atlant3d.com

BUSINESS DEVELOPMENT & SALES

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A-HUB & STRATEGIC PARTNERSHIPS

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